

# **PRODUCT SPECIFICATION**

## 16\*2 Characters COB LCD MODULE MODEL: LT-1602F2-692 Ver:1.2

< $\diamond$  > Finally Specification

|            | CUSTOMER'S | S APPROVAL |
|------------|------------|------------|
| CUSTOMER : |            |            |
| SIG        | NATURE:    | DATE:      |
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| APPROVED | PM      | PD      | PREPARED |
|----------|---------|---------|----------|
| BY       | REVIEWD | REVIEWD | Ву       |
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• This specification is subject to change without notice. Please contact LT or its representative before designing your product based on this specification.

## **Revision Status**

| Revision Status |             |      |              |             |  |  |
|-----------------|-------------|------|--------------|-------------|--|--|
| Version         | Revise Date | Page | Content      | Modified By |  |  |
| VER 1.0         | 2017.06.14  |      | First Issued |             |  |  |
| VER 1.1         | 2017.09.14  |      | Change IC    |             |  |  |
| VER 1.2         | 2018.01.08  |      | Change IC    |             |  |  |
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### 1. Features

The features of LCD are showed as follows

- \* Display mode : FSTN/Transflective/Positive
- \* Controller IC : ST7066-0A(English & Japanese)
- \* Display format : 16X2 Characters
- \* Interface Input Data : 4bit or 8 bit MPU
- \* Driving Method : 1/16Duty, 1/5Bias
- \* Viewing Direction : 6 O'clock
- \* Backlight

### : 2 LED/SideWhite

\*Sample NO. : C1602C5FSW6B-B3 02/20180105

## 2. MECHANICAL SPECIFICATIONS

| Item                  | Specification           | Unit |
|-----------------------|-------------------------|------|
| Module Size           | 80(W) x36(H) x9.5MAX(D) | mm   |
| Viewing Area          | 64.5(W) x 16(H)         | mm   |
| Activity Display Area | 56.21(W)x11.50(H)       | mm   |
| Character Font        | 5x8 Dots                | -    |
| Character Size        | 2.96(W)x5.56(H)         | mm   |
| Character Pitch       | 3.55(W)x5.94(H)         | mm   |
| Dot Size              | 0.56(W)x0.66(H)         | mm   |

## **3. ELECTRICAL SPECIFICATIONS**

3-1 ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

| Item                         | Symbol           | Min    | Max     | Unit |
|------------------------------|------------------|--------|---------|------|
| Supply Voltage For Logic     | Vdd              | 0.3    | 7       | V    |
| Supply Voltage For LCD Drive | V <sub>LCD</sub> | Vdd-15 | VDD+0.3 | V    |
| Input Voltage                | Vin              | -0.3   | VDD+0.3 | V    |
| Operating Temp.              | Тор              | -20    | +70     | °C   |
| Storage Temp.                | Tst              | -30    | +80     | °C   |

\*. NOTE: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

#### **3-2 ELECTICAL CHARACTERISTICS**

| ltem                 |           | Symbol                  | Test<br>Condition | Min.           | Тур. | Max.                        | Unit |
|----------------------|-----------|-------------------------|-------------------|----------------|------|-----------------------------|------|
| Logic supply Voltage |           | Vdd – Vss               |                   | 4.5            | 5    | 5.5                         | V    |
| LCD Drive            |           | V <sub>OP</sub> =VDD-V0 | Ta = 25 °C        | 4.3            | 4.5  | 4.7                         | V    |
| Input Voltage        | "H" Level | V <sub>IH</sub>         | Vdd=5V ± 10%      | $0.7^{V_{DD}}$ | -    | $V_{\scriptscriptstyle DD}$ | V    |
|                      | "L" Level | V <sub>IL</sub>         | 1070              | -0.3           | -    | 0.6                         | V    |
| Frame Frequency      |           | f <sub>FLM</sub>        |                   | -              | 84.4 | -                           | Hz   |
| Current Cons         | umption   | I <sub>DD</sub>         |                   | -              | 2.0  | -                           | mA   |

### 3-3 BACKLIGHT

### 3-3-1. Absolute Maximum Ratings

| ltem              | Symbol | Condition  | Min. | Тур. | Max. | Unit |
|-------------------|--------|------------|------|------|------|------|
| Forward Current   | IF     |            | -    | -    | 40   | mA   |
| Power Dissipation | PD     | Ta = 25 °C | -    | -    | 132  | mW   |
| Reverse current   | lr     | Vr=5V      | -    | -    | 15   | uA   |

### 3-3-2. Electrical-optical Characteristics

| Item                       | Symbol | Condition  | Min. | Тур. | Max. | Unit              |
|----------------------------|--------|------------|------|------|------|-------------------|
| Forward Voltage            | VF     |            | 2.8  | 3.1  | 3.2  | V                 |
| Average Luminous Intensity | Lv     | lf=30mA    | 200  | 280  | -    | cd/m <sup>2</sup> |
| Color coordinate           | Х      | Ta = 25 °C | 0.25 | 0.28 | 0.32 |                   |
|                            | Y      |            | 0.25 | 0.28 | 0.32 |                   |

The brightness is measured without LCD panel

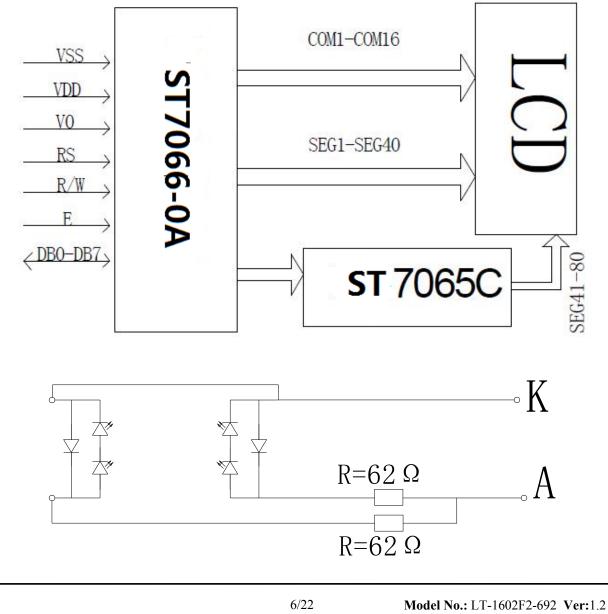
For operation above 25 °C,The lfm & Pd must be derated , the current derating is -0.36mA/ °C for DC drive and -0.86mA/ °C for Pulse drive ,the Power dissipation is -0.75mW/ °C.The product working current must not more than the 60% of the lfm or lfp according to the working temperature.

## 4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

### 4-1 INTERFACE PIN FUNCTION DESCRIPTION

| PIN NO. | SYMBOL  | FUNCIONS  |
|---------|---------|---|
| 1       | VSS     | Ground  |
| 2       | VDD     | Supply voltage for logical circuit  |
| 3       | V0      | Supply voltage for LCD driving  |
| 4       | RS      | A signal for selecting registers.<br>1: Data Register (for read and write)<br>0: Instruction Register (for write) |
| 5       | R/W     | A signal for selecting read or write actions.1: Read, 0: Write.   |
| 6       | E       | Enable signal for reading or writing data.  |
| 7-14    | DB0-DB7 | 8 Bit Data Bus  |
| 15      | К       | Backlight (-)   |
| 16      | Α       | Backlight (+) (5V)  |

### 4-2 BLOCK DIAGRAM



25

\_

\_

100

-

ns

ns

ns

ns

ns

-

0

10

-

10

-

-

\_

-

-

### **5. TIMING CHARACTERISTICS**

### 5-1 Reading data from ST7066U to MPU

Enable Rise/Fall Time Pin E

Address Hold Time

Data Setup Time

Data Hold Time

Address Setup Time Pins: RS,RW,E

Pins: RS,RW,E

Pins: DB0 - DB7

Pins: DB0 - DB7

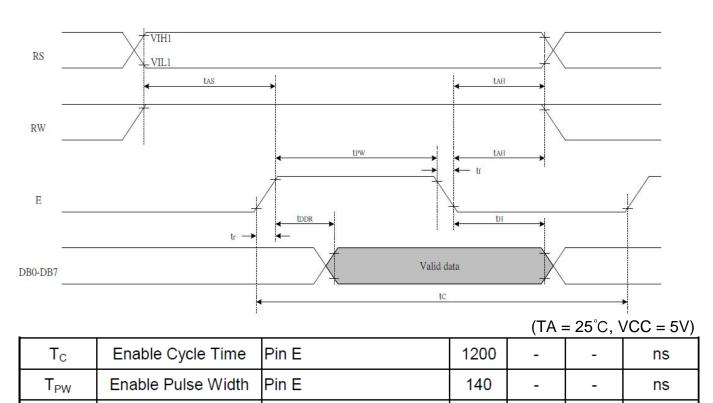
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T<sub>AS</sub>

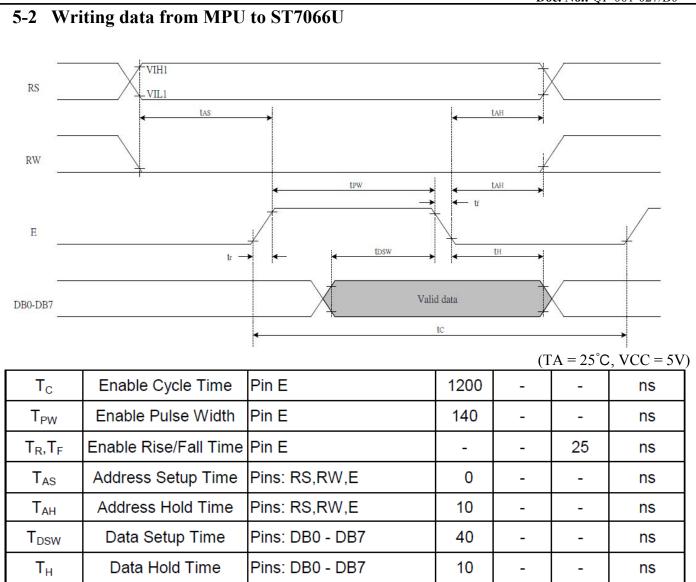
T<sub>AH</sub>

 $\mathsf{T}_{\mathsf{DDR}}$ 

 $T_{\rm H}$ 

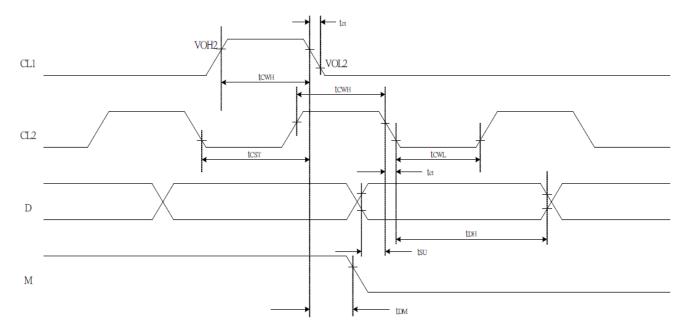


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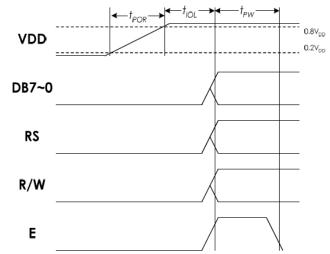
### 5-3 With External Driver



 $(TA = 25^{\circ}C, VCC = 5V)$ 

| T <sub>CWH</sub> | Clock Pulse with High | Pins: CL1, CL2 | 800                | - | -    | ns |
|------------------|-----------------------|----------------|--------------------|---|------|----|
| T <sub>CWL</sub> | Clock Pulse with Low  | Pins: CL1, CL2 | 800                | - | -    | ns |
| T <sub>CST</sub> | Clock Setup Time      | Pins: CL1, CL2 | 5 <mark>0</mark> 0 | - | -    | ns |
| T <sub>SU</sub>  | Data Setup Time       | Pin: D         | 300                | - | -    | ns |
| T <sub>DH</sub>  | Data Hold Time        | Pin: D         | 300                | - | -    | ns |
| T <sub>DM</sub>  | M Delay Time          | Pin: M         | 0                  | - | 2000 | ns |

### **5-4 Power Supply Conditions**



| Symbol | Characteristics    | Description   | Min.     | Тур.      | Max. | Unit |
|--------|--------------------|---|----------|-----------|------|------|
| tPOR   | Power rise time    | Power rise time that will trigger internal power on reset circuit | 0.1      |           | 100  | ms   |
| tIOL   | I/O Low time       | The period that I/O is kept low.                                  | 40       |           |      | ms   |
| tPW    | Enable pulse width | Please refer to the   | followin | ig tables | 3.   |      |

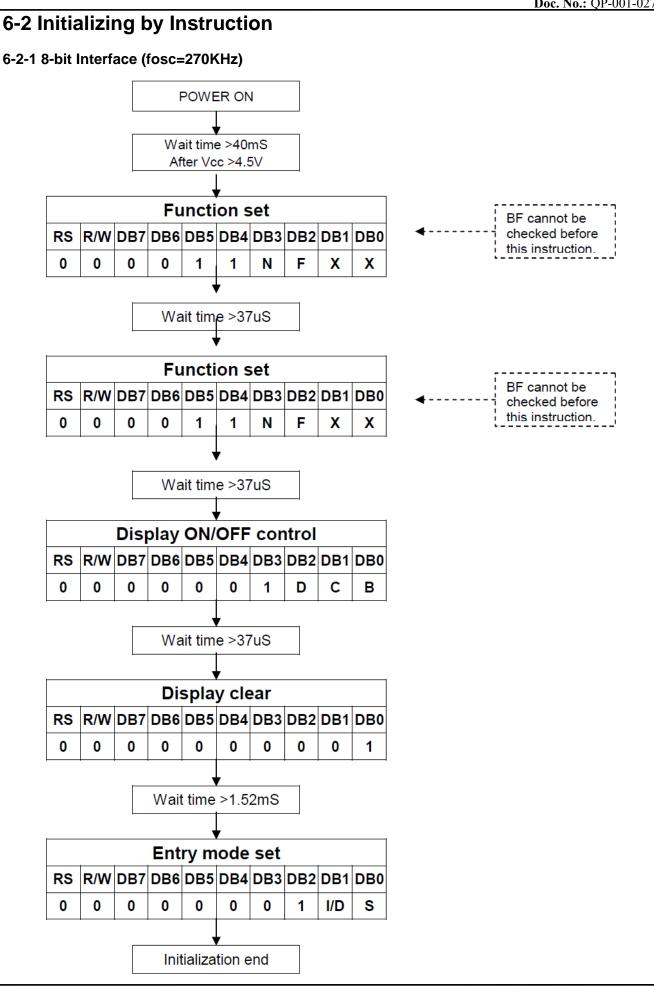
- 1. During tPOR, VDD noise should be reduced (especially close to 2.0V). Otherwise the Power-ON-Reset function might be triggered several times and maybe cause unexpected result.
- 2. During tIOL, the I/O ports of the interface (control and data signals) should be kept at "Low".

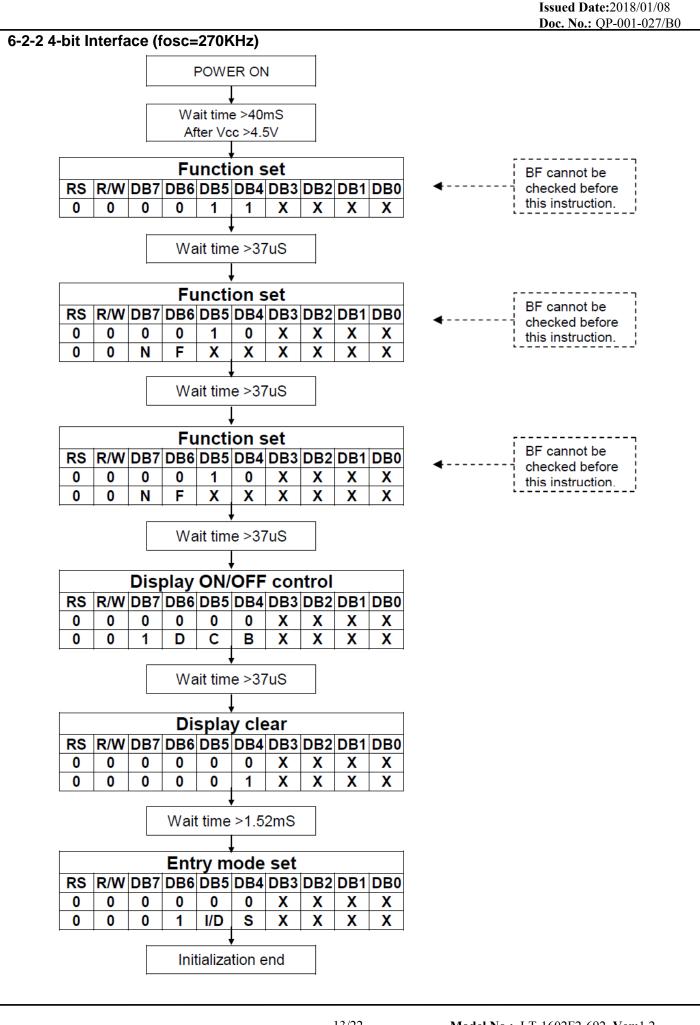
### 6. COMMAND LIST

|                                  |    |     |     | Inst | ructi | on C | Code | •   |     |     |  | Description      |
|----------------------------------|----|-----|-----|------|-------|------|------|-----|-----|-----|--|------------------|
| Instruction                      | RS | R/W | DB7 | DB6  | DB5   | DB4  | DB3  | DB2 | DB1 | DB0 | Description  | Time<br>(270KHz) |
| Clear<br>Display                 | 0  | 0   | 0   | 0    | 0     | 0    | 0    | 0   | 0   | 1   | Write "20H" to DDRAM. and<br>set DDRAM address to<br>"00H" from AC   | 1.52 ms          |
| Return<br>Home                   | 0  | 0   | 0   | 0    | 0     | 0    | 0    | 0   | 1   | x   | Set DDRAM address to<br>"00H" from AC and return<br>cursor to its original position<br>if shifted. The contents of<br>DDRAM are not changed. | 1.52 ms          |
| Entry Mode<br>Set                | 0  | 0   | 0   | 0    | 0     | 0    | 0    | 1   | I/D | S   | Sets cursor move direction<br>and specifies display shift.<br>These operations are<br>performed during data write<br>and read.               | 37 us            |
| Display<br>ON/OFF                | 0  | 0   | 0   | 0    | 0     | 0    | 1    | D   | с   | в   | D=1:entire display on<br>C=1:cursor on<br>B=1:cursor position on   | 37 us            |
| Cursor or<br>Display<br>Shift    | 0  | 0   | 0   | 0    | 0     | 1    | S/C  | R/L | x   | x   | Set cursor moving and<br>display shift control bit, and<br>the direction, without<br>changing DDRAM data.                                    | 37 us            |
| Function<br>Set                  | 0  | 0   | 0   | 0    | 1     | DL   | N    | F   | x   | x   | DL:interface data is 8/4 bits<br>N:number of line is 2/1<br>F:font size is 5x11/5x8  | 37 us            |
| Set CGRAM<br>address             | 0  | 0   | 0   | 1    | AC5   | AC4  | AC3  | AC2 | AC1 | AC0 | Set CGRAM address in<br>address counter  | 37 us            |
| Set DDRAM<br>address             | 0  | 0   | 1   | AC6  | AC5   | AC4  | AC3  | AC2 | AC1 | AC0 | Set DDRAM address in<br>address counter  | 37 us            |
| Read Busy<br>flag and<br>address | 0  | 1   | BF  | AC6  | AC5   | AC4  | AC3  | AC2 | AC1 | AC0 | Whether during internal<br>operation or not can be<br>known by reading BF. The<br>contents of address counter<br>can also be read.           | 0 us             |
| Write data<br>to RAM             | 1  | 0   | D7  | D6   | D5    | D4   | D3   | D2  | D1  | D0  | Write data into internal<br>RAM<br>(DDRAM/CGRAM)   | 37 us            |
| Read data<br>from RAM            | 1  | 1   | D7  | D6   | D5    | D4   | D3   | D2  | D1  | D0  | Read data from internal<br>RAM<br>(DDRAM/CGRAM)  | 37 us            |

Note:

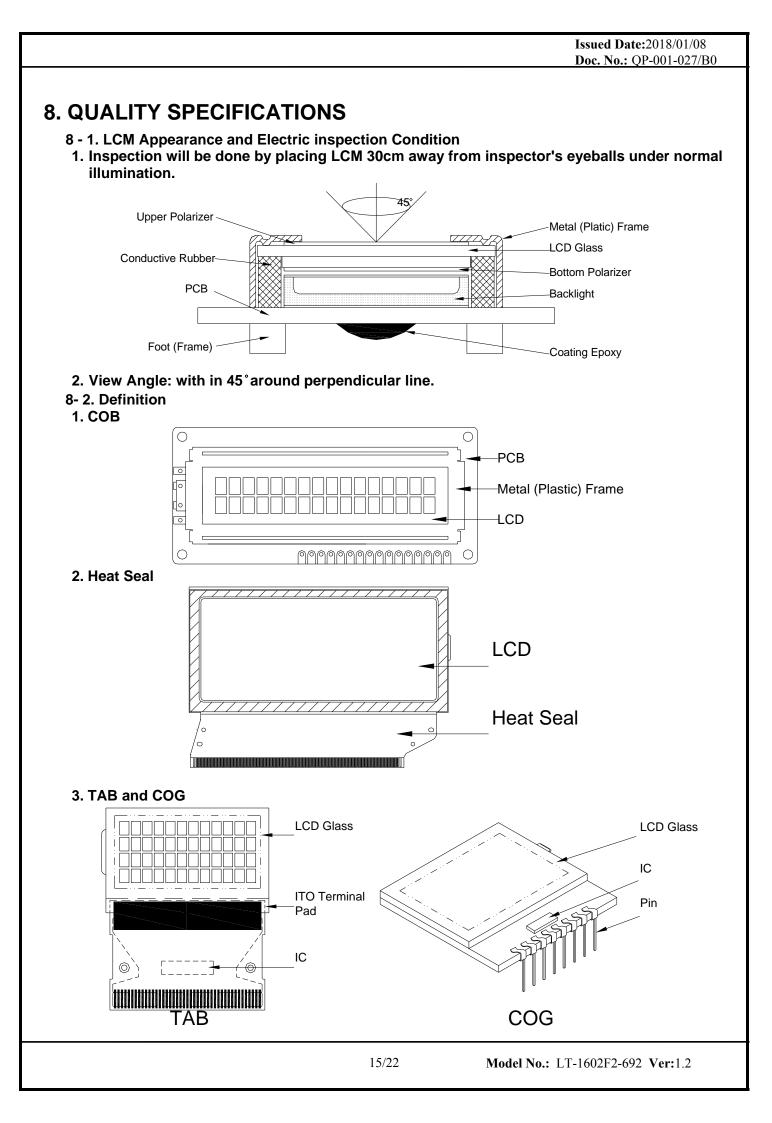
Be sure the ST7066U is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.





# 7. CHARACTER GENERATOR ROM

| 67-64<br>63-60 | 0000             | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|----------------|------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| 0000           | CG<br>RAM<br>(1) |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0001           | (2)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0010           | (3)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0011           | (4)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0100           | (5)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0101           | (6)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0110           | 7)               |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 0111           | (8)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1000           | (1)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1001           | (2)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1010           | (3)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1011           | (4)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1100           | (5)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1101           | (6)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1110           | 7)               |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| 1111           | (8)              |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |



### 8-3. Sampling Plan and Acceptance

### 1.Sampling Plan

MIL - STD - 105E (  $\parallel$  ) ordinary single inspection is used.

| 2.Acceptance  |             |
|---------------|-------------|
| Major defect: | AQL = 0.65% |
| Minor defect: | AQL = 1.5%  |

### 8-4. Criteria

#### 1.COB

| 1.000  |                               |  |        |
|--------|-------------------------------|--|--------|
| Defect | Inspection Item               | Inspection Standards   |        |
| Major  | PCB copper flakes peeling off | Any copper flake in viewing Area should be greater than 1.0mm <sup>2</sup> | Reject |
| Major  | Height of coating epoxy       | Exceed the dimension of drawing  | Reject |
| Major  | Void or hole of coating epoxy | Expose bonding wire or IC  | Reject |
| Major  | PCB cutting defect            | Exceed the dimension of drawing  | Reject |

#### 2. SMT

| Defect | Inspection Item  | Inspection Standa                  | ards             |
|--------|--|------------------------------------|------------------|
| Minor  | Component marking not readable   |                                    | Reject           |
| Minor  | Component height   | Exceed the dimension<br>Of drawing | Reject           |
| Major  | Component solder defect (missing , extra, wrong component or wrong orientation   |                                    | Reject           |
| Minor  | Component position shift<br>x component soldering pad<br>$x$ $\rightarrow$ | X < 3/4Z<br>Y > 1/3D               | Reject<br>Reject |
| Minor  | Component tilt<br>component<br>D<br>soldering pad  | Y > 1/3D                           | Reject           |
| Minor  | Insufficient solder<br>component<br>PAD<br>PCB   | <i>θ</i> <u>&lt;</u> 20°           | Reject           |

| 3. | Metal (Plasti | c) Frame                 |  |  | <b>DOC. NO</b> QI-001           |  |
|----|---------------|--------------------------|--|--|---------------------------------|--|
|    | Defect        | Inspection Item          | Ir   | spection Standar   | ds                              |  |
|    | Major         | Crack / breakage         | Any  | Reject   |                                 |  |
|    |               |                          | W  | L  | Acceptable of<br>Scratch        |  |
|    | Minor         |                          | w<0.1mm  | Any  | Ignore                          |  |
|    |               |                          | 0.1 <u>&lt;</u> w<0.2mm  | L <u>&lt;</u> 5.0mm  | 2                               |  |
|    |               | Frame Scratch            | 0.2 <u>&lt;</u> w<0.3mm  | L <u>&lt;</u> 3.0mm  | 1                               |  |
|    |               |                          | w <u>&gt;</u> 0.3mm  | Any  | 0                               |  |
|    |               |                          | with distance gr   | e criteria applicable<br>eater than 5mm.<br>on the back sid<br>gnored. |                                 |  |
| -  |               |                          |  | <u> </u>   | Acceptable of<br>Dents / Pricks |  |
|    |               |                          | Ф <u>&lt;</u>  | 2  |                                 |  |
|    |               | Frame Dent, Prick        | <b>1.0&lt;</b> Φ   | 9 <u>&lt;</u> 1.5mm  | 1                               |  |
|    | Minor         | $\Phi = \frac{L + W}{2}$ | 1.5n   | 0  |                                 |  |
|    |               | 2                        | Note : 1. Above criteria applicable to any two den<br>/ pricks with distance greater than 5mm<br>2. Dent / prick on the back side of frame (n<br>visible) can be ignored |  |                                 |  |
|    | Minor         | Frame Deformation        | Exceed   | d the dimension of   | drawing                         |  |
|    | Minor         | Metal Frame Oxidation    |  | Any rust   |                                 |  |

### 4. Flexible Film Connector (FFC)

| Defect | Insp                                | ection Item                              | Inspection Standa          | rds        |  |
|--------|-------------------------------------|--|----------------------------|------------|--|
| Minor  | Tilte                               | d soldering                              | Within the angle +5°       | Acceptable |  |
| Minor  | Uneven s                            | older joint /bump                        |                            | Reject     |  |
|        |                                     |  | Expose the conductive line | Reject     |  |
| Minor  | Minor Hole $\Phi = \frac{L + W}{2}$ | $\Phi$ > 1.0mm                           | Reject                     |            |  |
| Minor  | Y-*-                                | sition shift<br>→ <sup>,Z</sup> ← ↓<br>□ | Y > 1/3D                   | Reject     |  |
| WITIO  |                                     |  | X > 1/2Z                   | Reject     |  |

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### 5. Screw

| Defect | Inspection Item      | Inspection Standards             |        |  |
|--------|----------------------|----------------------------------|--------|--|
| Major  | Screw missing/loosen |                                  | Reject |  |
| Minor  | Screw oxidation      | Any rust                         | Reject |  |
| Minor  | Screw deformation    | Difficult to accept screw driver | Reject |  |

#### 6. Heatseal TCP FPC

| Defect | Inspection Item   | Inspection Standards        |        |
|--------|---|-----------------------------|--------|
| Major  | Scratch expose conductive layer   |                             | Reject |
| Minor  | HS Hole $\Phi = \frac{L + W}{2}$  | $\Phi$ > 0.5mm              | Reject |
| Major  | Adhesion strength   | Less than the specification | Reject |
| Minor  | Position shift<br>$Y \xrightarrow{-\psi} -\psi$ | Y > 1/3D                    | Reject |
| WIITO  |   | X > 1/2Z                    | Reject |
| Major  | Conductive line break   |                             | Reject |

### 7. LED Backing Protective Film and Others

| Defect | Inspection Item      | Inspection Standards  |        |
|--------|----------------------|---|--------|
|        |                      | Acceptable number of units  |        |
|        |                      | ⊕ <u>&lt;</u> 0.10mm  | Ignore |
|        |                      | 0.10<⊕ <u>&lt;</u> 0.15mm   | 2      |
| Minor  | LED dirty, prick     | 0.15<⊕ <u>&lt;</u> 0.2mm  | 1      |
|        |                      | $\Phi$ >0.2mm   | 0      |
|        |                      | The distance between any two spots should be $\geq$ Any spot/dot/void outside of viewing area is acce |        |
| Minor  | Protective film tilt | Not fully cover LCD   | Reject |
| Major  | COG coating          | Not fully cover ITO circuit   | Reject |

### 8. Electric Inspection

| Defect | Inspection Item | Inspection Standards |        |
|--------|-----------------|----------------------|--------|
| Major  | Short           |                      | Reject |
| Major  | Open            |                      | Reject |

| Defect | Insp                          | ect Item  |             |   | Ins                   | spection                                 | ו S              | tandards                                  | 6                |                  |
|--------|-------------------------------|---|-------------|---|-----------------------|--|------------------|---|------------------|------------------|
|        |                               | * Glass Scratch   | W           |   | W <u>&lt;</u>         | 0.03                                     | 0                | .03 <w<u>&lt;0.0</w<u>                    | 5 V              | V>0.05           |
|        |                               | * Polarizer Scratch   | L           |   | L                     | <5                                       |                  | L<3                                       |                  | Any              |
| Minor  | Linear Defect                 | * Fiber and Linea   | ACC.<br>NO. | · 1   |                       |  | 1                |   | Reject           |                  |
|        |                               | material  | Note        |   |                       | -  |                  | ne width of                               |                  |                  |
|        |                               | * Foreign materia   |             | Φ <u>&lt;</u> (   |                       | 0.1<⊕ <u>&lt;</u> (                      | 0.15             | 0.15<⊕ <u>&lt;</u> 0                      | .2               | Φ <b>&gt;0.2</b> |
| Minor  | Black Spot and                |   |             | 3E/<br>100m   | A/<br>nm <sup>2</sup> | 2  |                  | 1   |                  | 0                |
|        | Polarizer<br>Pricked          | and glass<br>* Polarizer hole o<br>protuberance by<br>external force                            | Note        | $\Phi$ is the average diameter of the defect.<br>Distance between two defects > 10mm. |                       |  |                  |   |                  |                  |
|        |                               | * Unobvious   | -           |   | ⊕ <u>&lt;</u> (       | 0.3                                      | 0.3              | 8<⊕ <u>&lt;</u> 0.5                       | 0.               | <b>5&lt;</b> Φ   |
|        | White Spot                    | transparant foreigr<br>material betweer   | NO.         | 3EA   | 4 / 10                | 00mm <sup>2</sup>                        |                  | 1   |                  | 0                |
| Minor  | and Bubble in polarizer       | glass and glass o<br>glass and polarizer<br>* Air protuberance<br>between polarize<br>and glass | Note        |   |                       | -  |                  | er of the de<br>fects > 10n               |                  |                  |
|        |                               |   | Φ           | ⊕ <u>&lt;</u> 0   | .10                   | 0.10<⊕ <u>&lt;</u>                       | <u>&lt;</u> 0.20 | <b>0.20&lt;</b> ⊕∢                        | <u>&lt;</u> 0.25 | Ф>0              |
|        |                               |   | ACC.<br>NO. | 3EA<br>100m   | ۸/<br>hm²             | 2  |                  | 1   |                  | 0                |
| Minor  | Segment<br>Defect             |   |             | W is more than 1/2 segment width  |                       |  |                  | Reje                                      |                  |                  |
|        | Delect                        |   | Note        | $\Phi = \frac{L + W}{2}$<br>Distance between two defect is 10mm                       |                       |  |                  |   |                  |                  |
|        |                               |   | Φ           | Φ <u>&lt;</u> 0.10 0.10<Φ <u>&lt;</u> 0   |                       | <u>&lt;</u> 0.20 0.20<⊕ <u>&lt;</u> 0.25 |                  | <u>&lt;</u> 0.25                          | Ф <b>&gt;0</b>   |                  |
|        | Protuberant                   | w K   | W           | Glu   | ie                    | W <u>&lt;</u> 1/2<br>W <u>&lt;</u> 0     |                  | W <u>&lt;</u> 1/2<br>W <u>&lt;</u> 0      | •                | Igno             |
| Minor  | Segment                       | $\Phi = (L + W) / 2$  | ACC.<br>NO. | 3EA<br>100m   | A /<br>nm²            | 2  |                  | 1   |                  | 0                |
|        |                               |   | 1. Seg      | ment  |                       |  |                  |   |                  | •                |
|        |                               |   | E           |   |                       | 0.4mm                                    |                  | B <u>&lt;</u> 1.0mm                       |                  | 1.0mm            |
| Minor  | Assembly<br>Mis-alignment     |   |             |   |                       | -A<1/2B                                  |                  |   |                  | <0.25<br>eptabl  |
|        | g                             | *****   | 2. Dot      | t Matrix  |                       |  |                  |   |                  |                  |
|        |                               |   |             | Deformation>2°  |                       |  |                  |   | Reje             |                  |
| Minor  | Stain on LCD<br>Panel Surface |   | ora         | similar   | one                   | e. Otherw                                | ise,             | ed lightly w<br>judged aco<br>Vhite Spot" |                  |                  |

## 9. RELIABILITY

| No | Item                        | Condition   | Quantity | Criteria                 |
|----|-----------------------------|---|----------|--------------------------|
| 1  | High Temperature Operating  | 70℃, 96Hrs  | 2        | GB/T2423.2<br>-2008      |
| 2  | Low Temperature Operating   | -20°C, 96Hrs  | 2        | GB/T2423.1<br>-2008      |
| 3  | High Humidity               | 60°C, 90%RH, 96Hrs  | 2        | GB/T2423.3<br>-2006      |
| 4  | High Temperature Storage    | 80°C, 96Hrs   | 2        | GB/T2423.2<br>-2008      |
| 5  | Low Temperature Storage     | -30°C, 96Hrs  | 2        | GB/T2423.1<br>-2008      |
| 6  | Thermal Cycling Test        | -20°C, 60min~70°C, 60min,<br>20 cycles.   | 2        | GB/T2423.2<br>2<br>-2012 |
| 7  | Packing vibration           | Frequency range:10Hz~50Hz<br>Acceleration of gravity:5G<br>X,Y,Z 30 min for each direction. | 2        | GB/T5170.1<br>4<br>-2009 |
| 8  | Electrical Static Discharge | Air: $\pm$ 8KV 150pF/330 $\Omega$ 5 times   | 2        | GB/T17626.<br>2<br>-2006 |
|    |                             | Contact: $\pm 4$ KV 150pF/330 $\Omega$ 5 times  |          |                          |
| 9  | Drop Test<br>(Packaged)     | Height:80 cm,1 corner, 3 edges,<br>6 surfaces.  | 2        | GB/T2423.8<br>-1995      |

Note: 1) Above conditions are suitable for our company standard products. 2) For restrict products, the test conditions listed as above must be revised.

## **10. HANDLING PRECAUTION**

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichloro trifloro thane

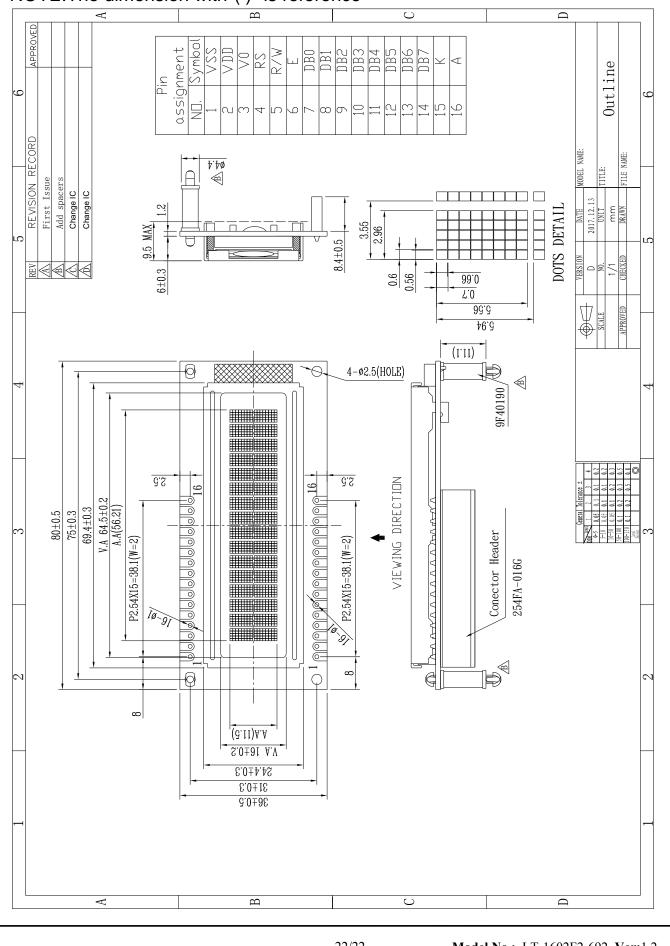
Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Ketone
- Aromatics
- (3) Caution against static charge
  - The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.
- (4) Packaging
  - Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
  - To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.
- (5) Caution for operation
  - It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
  - Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.
  - If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
  - A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
  - Usage under the relative condition of 40°C, 50%RH or less is required.
- (6) Storage
  - In the case of storing for a long period of time (for instance.) For years) for the purpose or replacement use, The following ways are recommended.
    - Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
  - Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
  - Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)
- (7) Safety
  - It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol. Which should be burned up later.
  - When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

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## **11. OUTLINE DIMENSION**

### NOTE: The dimension with"()" is reference



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